February 2008



74LCX541 Low Voltage Octal Buffer/Line Driver with 5V Tolerant Inputs and Outputs

Features

- 5V tolerant input and outputs
- 2.3V–3.6V V_{CC} specifications provided
- 6.5ns t_{PD} max (V_{CC} = 3.3V), 10µA I_{CC} max
- Power-down high impedance inputs and outputs
- Supports live insertion/withdrawal⁽¹⁾
- ±24 mA output drive ($V_{CC} = 3.0V$)
- Implements patented noise/ EMI reduction circuitry
- Latch-up performance exceeds JEDEC 78 conditions
- ESD performance
 - Human body model > 2000V
 - Machine model > 200V
- Leadless DQFN package

Note:

 To ensure the high impedance state during power up or down, OE should be tied to V_{CC} through a pull-up resistor: the minimum value of the resistor is determined by the current-sourcing capability of the driver.

General Description

The LCX541 is an octal buffer/line driver designed to be employed as memory and address drivers, clock drivers and bus oriented transmitter/receivers. The LCX541 is a non inverting option of the LCX540.

This device is similar in function to the LCX244 while providing flow-through architecture (inputs on opposite side from outputs). This pinout arrangement makes this device especially useful as an output port for microprocessors, allowing ease of layout and greater PC board density.

The LCX541 is designed for low voltage applications with capability of interfacing to a 5V signal environment. The LCX541 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

Order Number	Package Number	Package Description
74LCX541WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74LCX541SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LCX541BQX ⁽²⁾	MLP20B	20-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 4.5mm
74LCX541MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide
74LCX541MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Ordering Information

Note:

2. DQFN package available in Tape and Reel only.

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

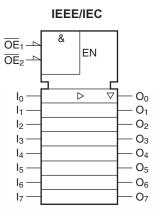
All packages are lead free per JEDEC: J-STD-020B standard.

Connection Diagrams Pin Assignments for SOIC, SOP, SSOP, TSSOP ²⁰ V<u>cc</u> OE₁ -19 OE₂ 2 I_0 18 O₀ 3 I_1 17 01 4 I_2 16 0₂ 5 l₃ <u>15</u> O₃ 6 I_4 14 O₄ 7 I_5 13 O₅ 8 I_6 12 O₆ 9 I_7 11 07 GND 10 Pad Assignment for DQFN **OE**₁ V_{CC} 20 1 (19 OE₂ I_0 2 18 O₀ I₁ 3 (17 O₁ I_2 4 (16 O₂ $I_3 5$ (15 O₃ **I**4 6 (14 O₄ I_5 7 l₆ 8 (13 O₅ 17 9 (12 O₆ 10 11 GND O7 (Top View)

Pin Descriptions

Pin Names	Description
$\overline{OE}_1, \overline{OE}_2$	3-STATE Output Enable Inputs
I ₀ -I ₇	Inputs
O ₀ -O ₇	Outputs

Logic Symbol



Truth Table

	Inputs		Outputs
OE ₁	OE ₂	I	On
L	L	Н	Н
Н	Х	Х	Z
Х	Н	Х	Z
L	L	L	L

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

Z = High Impedance

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Cor	nditions	Value	Units
V _{CC}	Supply Voltage			-0.5 to +7.0	V
VI	DC Input Voltage			-0.5 to +7.0	V
Vo	DC Output Voltage	Output in 3-ST	TATE	-0.5 to +7.0	V
		Output in HIG	H or LOW State ⁽³⁾	-0.5 to V _{CC} + 0.5	
I _{IK}	DC Input Diode Current	V _I < GND		-50	mA
I _{ОК}	DC Output Diode Current	V _O < GND		-50	mA
		$V_{O} > V_{CC}$		+50	
Ι _Ο	DC Output Source/Sink Current			±50	mA
I _{CC}	DC Supply Current per Supply Pin			±100	mA
I _{GND}	DC Ground Current per Ground Pin			±100	mA
T _{STG}	Storage Temperature			-65 to +150	°C

Recommended Operating Conditions⁽⁴⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Conditions	Min.	Max.	Units
V _{CC}	Supply Voltage	Operating	2.0	3.6	V
		Data Retention	1.5	3.6	
VI	Input Voltage		0	5.5	V
V _O	Output Voltage	HIGH or LOW State	0	V _{CC}	V
		3-STATE	0	5.5	
I _{OH} /I _{OL}	Output Current	V _{CC} = 3.0V–3.6V		±24	mA
		V _{CC} = 2.7V–3.0V		±12	
		$V_{CC} = 2.3V - 2.7V$		±8	
T _A	Free-Air Operating Temperature		-40	85	°C
$\Delta t / \Delta V$	Input Edge Rate	$V_{IN} = 0.8V - 2.0V, V_{CC} = 3.0V$	0	10	ns/V

Notes:

3. I_O Absolute Maximum Rating must be observed.

4. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

				$T_A = -40^{\circ}C$	to +85°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Min.	Max.	Units
V _{IH}	HIGH Level Input Voltage	2.3–2.7		1.7		V
		2.7–3.6		2.0		
V _{IL}	LOW Level Input Voltage	2.3–2.7			0.7	V
		2.7–3.6			0.8	
V _{OH}	HIGH Level Output Voltage	2.3–3.6	I _{OH} = -100μA	V _{CC} – 0.2		V
		2.3	I _{OH} = -8mA	1.8		
		2.7	$I_{OH} = -12 mA$	2.2		
		3.0	$I_{OH} = -18 \text{mA}$	2.4		
			I _{OH} = -24mA	2.2		
V _{OL}	LOW Level Output Voltage	2.3–3.6	I _{OL} = 100μA		0.2	V
		2.3	I _{OL} = 8mA		0.6	
		2.7	I _{OL} = 12mA		0.4	
		3.0	I _{OL} = 16mA		0.4	
			I _{OL} = 24mA		0.55	
lμ –	Input Leakage Current	2.3–3.6	$0 \le V_I \le 5.5V$		±5.0	μA
I _{OFF}	Power-Off Leakage Current	0	$V_{\rm I}$ or $V_{\rm O} = 5.5 V$		10	μA
Icc	Quiescent Supply Current	2.3–3.6	$V_I = V_{CC}$ or GND		10	μA
			$3.6V \le V_I, V_O \le 5.5V^{(5)}$		±10	
ΔI_{CC}	Increase in I _{CC} per Input	2.3–3.6	$V_{IH} = V_{CC} = 0.6V$		500	μA

AC Electrical Characteristics

			$T_A = -40^{\circ}C$ to +85°C, $R_L = 500\Omega$					
		V _{CC} = 3.3 C _L =	3V ± 0.3V, 50pF		2.7V, 50pF		5V ± 0.2V, 30pF	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Units
t _{PHL} , t _{PLH}	Propagation Delay	1.5	6.5	1.5	7.5	1.5	7.8	ns
t _{PZL} , t _{PZH}	Output Enable Time	1.5	8.5	1.5	9.5	1.5	10.5	ns
t _{PLZ} , t _{PHZ}	Output Disable Time	1.5	7.5	1.5	8.5	1.5	9.0	ns
t _{OSHL} , t _{OSLH}	Output to Output Skew ⁽⁶⁾		1.0					ns

Notes

5. Outputs disabled or 3-STATE only.

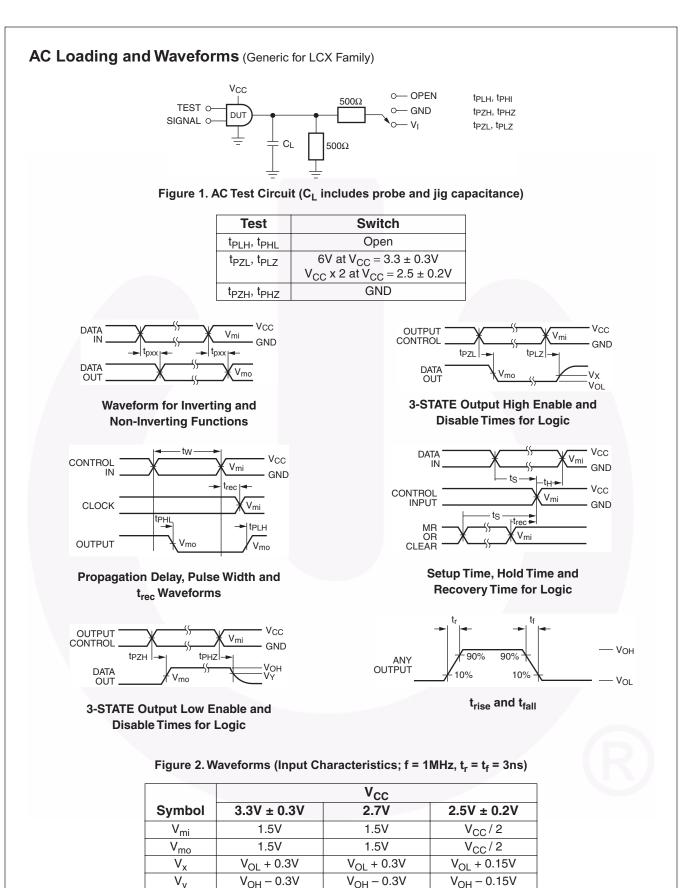
6. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

Dynamic Switching Characteristics

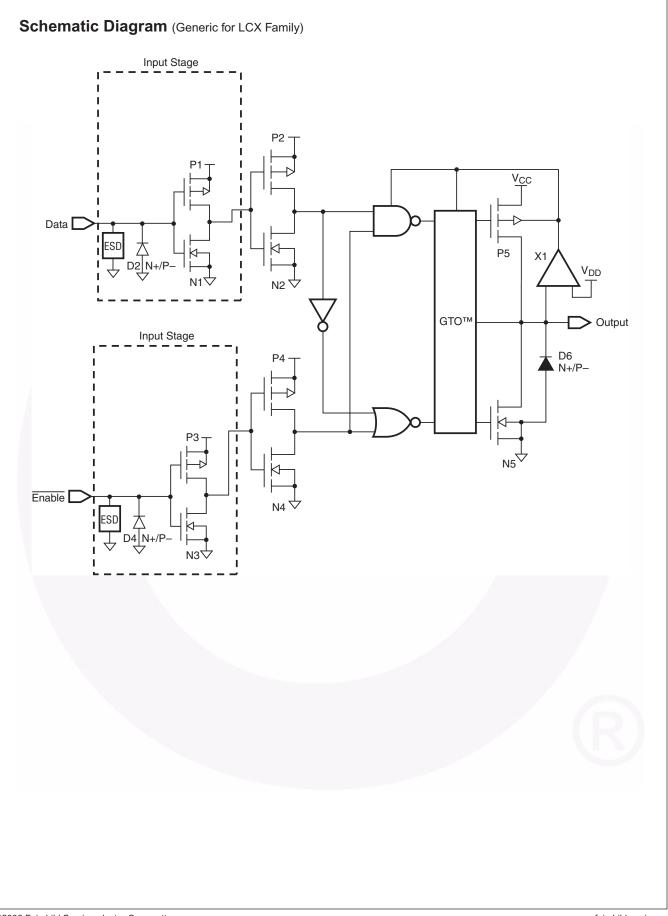
				$T_A = 25^{\circ}C$	
Symbol	Parameter	V _{CC} (V)	Conditions	Typical	Units
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	3.3	$C_L = 50 \text{ pF}, \text{ V}_{IH} = 3.3 \text{V}, \text{ V}_{IL} = 0 \text{V}$	0.8	V
		2.5	$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	0.6	
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	3.3	$C_{L} = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	-0.8	V
		2.5	$C_L = 30 \text{ pF}, V_{IH} = 2.5 \text{V}, V_{IL} = 0 \text{V}$	-0.6	

Capacitance

Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	7	pF
C _{OUT}	Output Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC} , f = 10 MHz	25	pF



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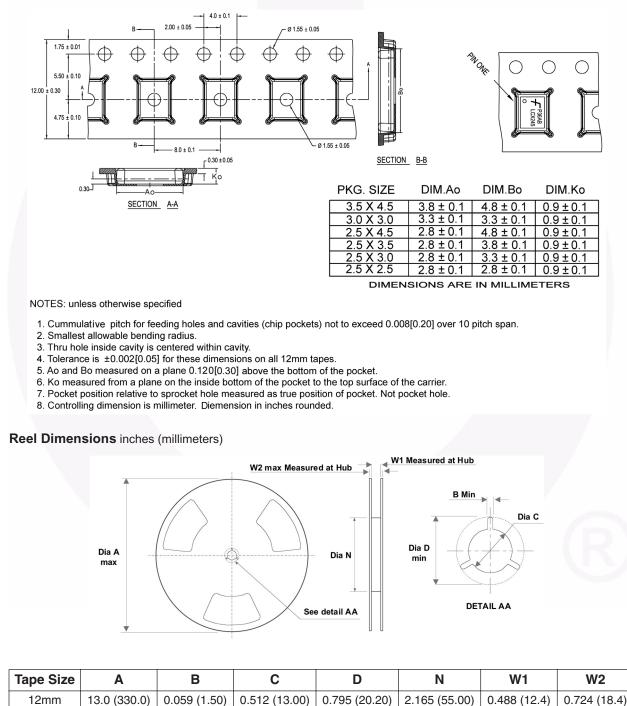
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Tape and Reel Specification

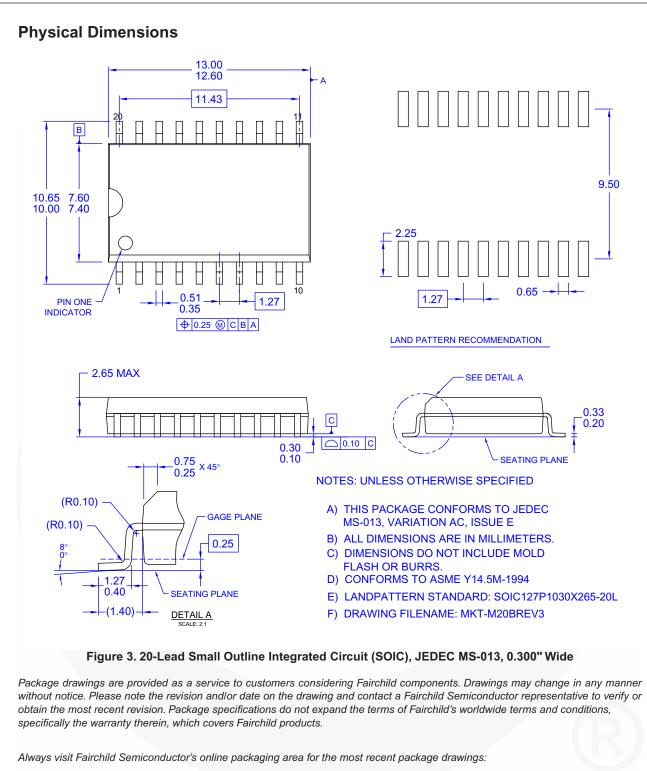
Tape Format for DQFN

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
BQX	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

Tape Dimensions inches (millimeters)

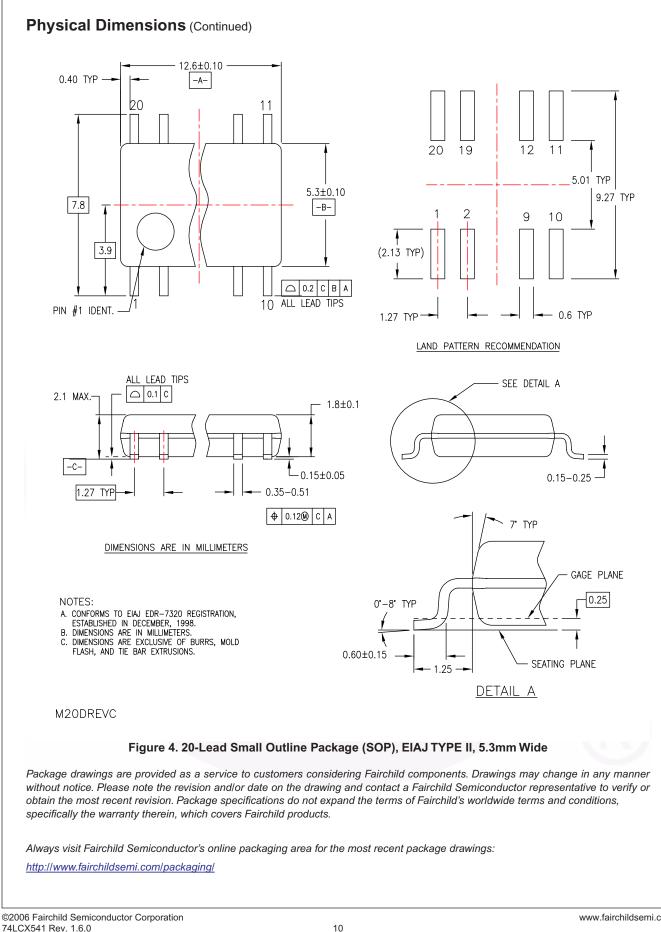


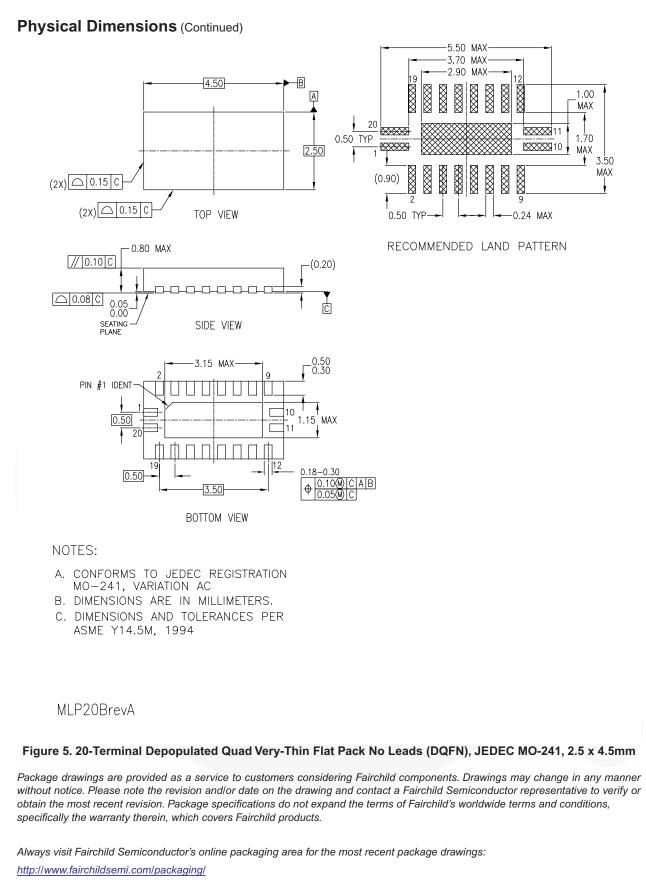
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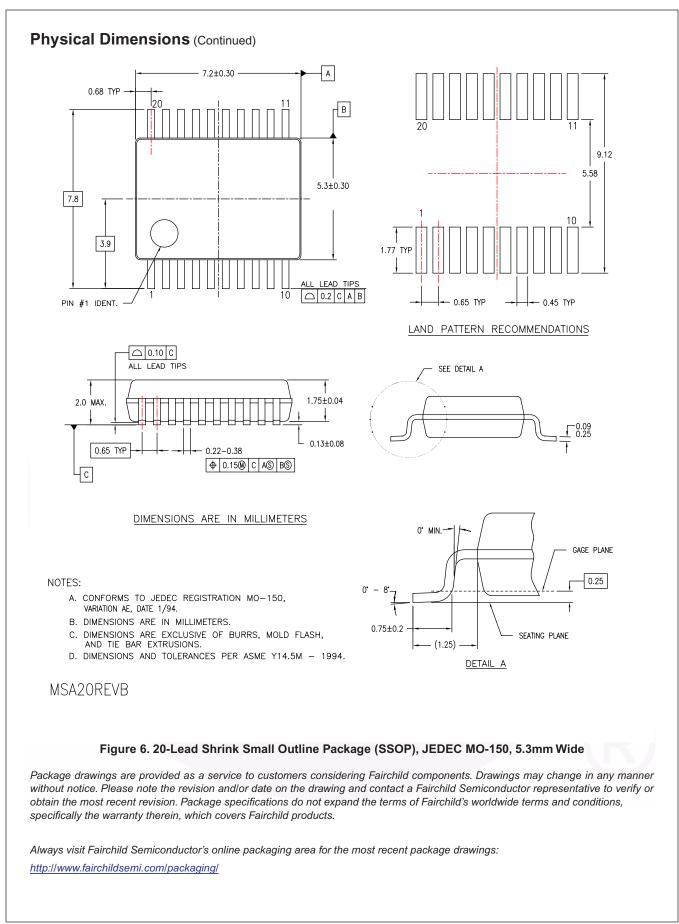




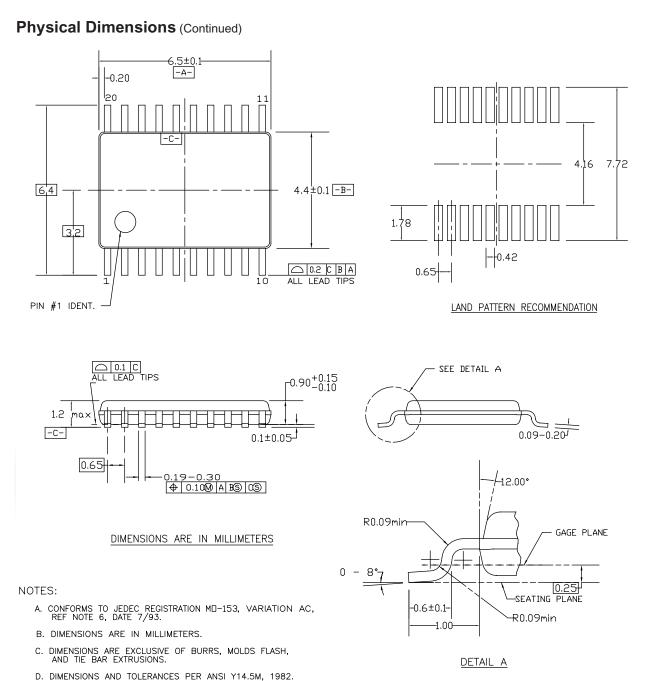
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MTC20REVD1

Figure 7. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

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